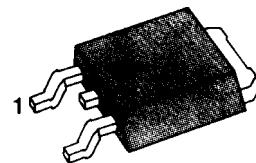
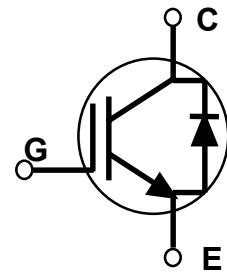


**FEATURES**

- \* High Speed Switching
- \* Low Saturation Voltage  
:  $V_{CE}(\text{sat}) = 2.1 \text{ V}$  (@  $I_C=3\text{A}$ )
- \* High Input Impedance
- \*CO-PAK, IGBT with FRD  
:  $\text{Tr}_r = 35\text{nS}$  (typ.)

**D<sup>2</sup>-PAK****APPLICATIONS**

- \* AC & DC Motor controls
- \* General Purpose Inverters
- \* Robotics , Servo Controls
- \* Power Supply
- \* Lamp Ballast

**ABSOLUTE MAXIMUM RATINGS**

| Symbol      | Characteristics   | Rating         | Units            |
|-------------|---|----------------|------------------|
| $V_{CES}$   | Collector-Emitter Voltage   | 600            | V                |
| $V_{GES}$   | Gate-Emitter Voltage  | $\pm 20$       | V                |
| $I_C$       | Collector Current @ $T_c = 25^\circ\text{C}$  | 6              | A                |
|             | Collector Current @ $T_c = 100^\circ\text{C}$   | 3              | A                |
| $I_{CM(1)}$ | Pulsed Collector Current  | 25             | A                |
| $I_F$       | Diode Continuous Forward Current @ $T_c = 100^\circ\text{C}$                          | 4              | A                |
| $I_{FM}$    | Diode Maximum Forward Current   | 25             | A                |
| $P_D$       | Maximum Power Dissipation @ $T_c = 25^\circ\text{C}$                                  | 30             | W                |
|             | Maximum Power Dissipation @ $T_c = 100^\circ\text{C}$                                 | 12             | W                |
| $T_j$       | Operating Junction Temperature  | $-55 \sim 150$ | $^\circ\text{C}$ |
| $T_{stg}$   | Storage Temperature Range   | $-55 \sim 150$ | $^\circ\text{C}$ |
| $T_L$       | Maximum Lead Temp. For Soldering<br>Purposes. $\frac{1}{8}''$ from case for 5 seconds | 300            | $^\circ\text{C}$ |

**Notes:**(1) Repetitive rating : Pulse width limited by max. junction temperature

**ELECTRICAL CHARACTERISTICS (IGBT PART)**  
 (T<sub>c</sub>=25°C, Unless Otherwise Specified)

| Symbol                                | Characteristics                            | Test Conditions  | Min | Typ | Max | Units |
|---------------------------------------|--|--|-----|-----|-----|-------|
| BV <sub>CES</sub>                     | C - E Breakdown Voltage                    | V <sub>GE</sub> = 0V , I <sub>C</sub> = 250µA  | 600 | -   | -   | V     |
| ΔV <sub>CES/</sub><br>ΔT <sub>J</sub> | Temperature Coeff. of<br>Breakdown Voltage | V <sub>GE</sub> = 0V , I <sub>C</sub> = 1mA  | -   | 0.6 | -   | V/°C  |
| V <sub>GE(th)</sub>                   | G - E threshold voltage                    | I <sub>C</sub> = 3mA , V <sub>CE</sub> = V <sub>GE</sub>   | 4.0 | 5.5 | 7.5 | V     |
| I <sub>CES</sub>                      | Collector cutoff Current                   | V <sub>CE</sub> = V <sub>CES</sub> , V <sub>GE</sub> = 0V  | -   | -   | 250 | uA    |
| I <sub>GES</sub>                      | G - E leakage Current                      | V <sub>GE</sub> = V <sub>GES</sub> , V <sub>CE</sub> = 0V  | -   | -   | 100 | nA    |
| V <sub>CE(sat)</sub>                  | Collector to Emitter<br>saturation voltage | Ic=3A, V <sub>GE</sub> = 15V   | -   | 2.1 | 2.6 | V     |
|                                       |  | Ic=6A, V <sub>GE</sub> = 15V   | -   | 2.6 | -   | V     |
| Cies                                  | Input capacitance                          | V <sub>GE</sub> = 0V , f = 1MHz<br><br>V <sub>CE</sub> = 30V   | -   | 220 | -   | pF    |
| Coes                                  | Output capacitance                         |  | -   | 34  | -   | pF    |
| Cres                                  | Reverse transfer capacitance               |  | -   | 7   | -   | pF    |
| td(on)                                | Turn on delay time                         | V <sub>CC</sub> = 300V , I <sub>C</sub> = 3A<br><br>V <sub>GE</sub> = 15V<br><br>R <sub>G</sub> = 80 Ω<br><br>Inductive Load | -   | 15  | -   | nS    |
| tr                                    | Turn on rise time                          |  | -   | 22  | -   | nS    |
| td(off)                               | Turn off delay time                        |  | -   | 40  | 70  | nS    |
| tf                                    | Turn off fall time                         |  | -   | 80  | 160 | nS    |
| Eon                                   | Turn on Switching Loss                     |  | -   | 75  | -   | uJ    |
| Eoff                                  | Turn off Switching Loss                    |  | -   | 30  | -   | uJ    |
| Ets                                   | Total Switching Loss                       |  | -   | 100 | 125 | uJ    |
| Qg                                    | Total Gate Charge                          | Vcc = 300V<br><br>V <sub>GE</sub> = 15V<br><br>Ic = 3A   | -   | 15  | 22  | nC    |
| Qge                                   | Gate-Emitter Charge                        |  | -   | 5   | 8   | nC    |
| Qgc                                   | Gate-Collector Charge                      |  | -   | 4   | 6   | nC    |
| Le                                    | Internal Emitter Inductance                | Measured 5mm from PKG  | -   | 7.5 | -   | nH    |

**ELECTRICAL CHARACTERISTICS (DIODE PART)**  
(T<sub>c</sub>=25°C, Unless Otherwise Specified)

| Symbol          | Characteristics                     | Test Conditions                    |                        | Min | Typ | Max | Units |
|-----------------|-------------------------------------|------------------------------------|------------------------|-----|-----|-----|-------|
| VFM             | Diode Forward Voltage               | IF=4.0A                            | T <sub>c</sub> =25 °C  | -   | 1.4 | 1.7 | V     |
|                 |                                     |                                    | T <sub>c</sub> =100 °C | -   | 1.3 | -   |       |
| Tr <sub>r</sub> | Diode Reverse Recovery Time         | IF=4.0A, VR=200V<br>-di/dt=200A/uS | T <sub>c</sub> =25 °C  | -   | 35  | 52  | nS    |
|                 |                                     |                                    | T <sub>c</sub> =100 °C | -   | 53  | -   |       |
| Irr             | Diode Peak Reverse Recovery Current | IF=4.0A, VR=200V<br>-di/dt=200A/uS | T <sub>c</sub> =25 °C  | -   | 3.5 | 5.0 | A     |
|                 |                                     |                                    | T <sub>c</sub> =100 °C | -   | 4.5 | -   |       |
| Qrr             | Diode Reverse Recovery Charge       |                                    | T <sub>c</sub> =25 °C  | -   | 60  | 135 | nC    |
|                 |                                     |                                    | T <sub>c</sub> =100 °C | -   | 120 | -   |       |

**THERMAL RESISTANCE**

| Symbol            | Characteristics                 | Min | Typ | Max | Units |
|-------------------|---------------------------------|-----|-----|-----|-------|
| R <sub>θ</sub> JC | Junction-to-Case (IGBT)         | -   | -   | 4.0 | °C/W  |
| R <sub>θ</sub> JC | Junction-to-Case (DIODE)        | -   | -   | 7.0 | °C/W  |
| R <sub>θ</sub> JA | Junction-to-Ambient (PCB mount) | -   | -   | 40  | °C/W  |

# SGW6N60UFD

## N-CHANNEL IGBT

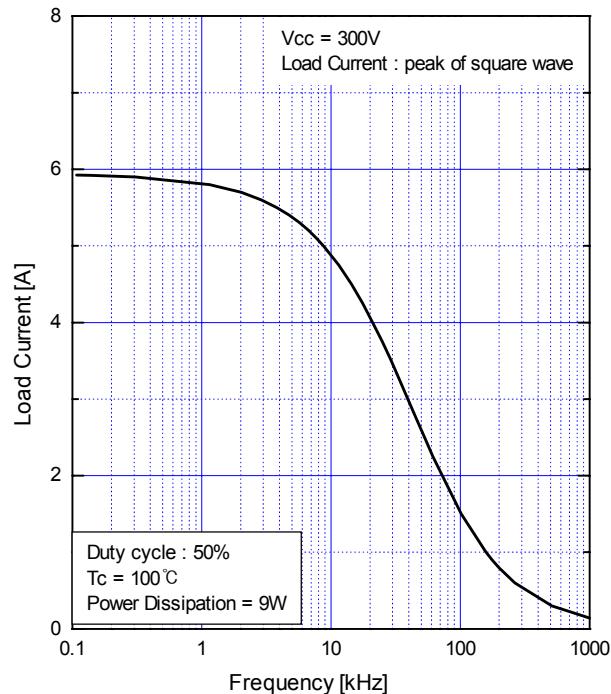


Fig.1 Typical Load Current vs. Frequency

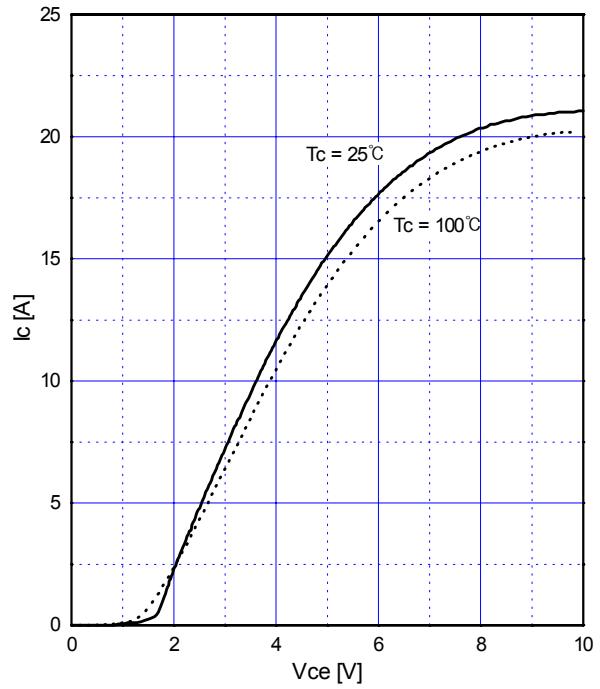


Fig.2 Typical Output Characteristics

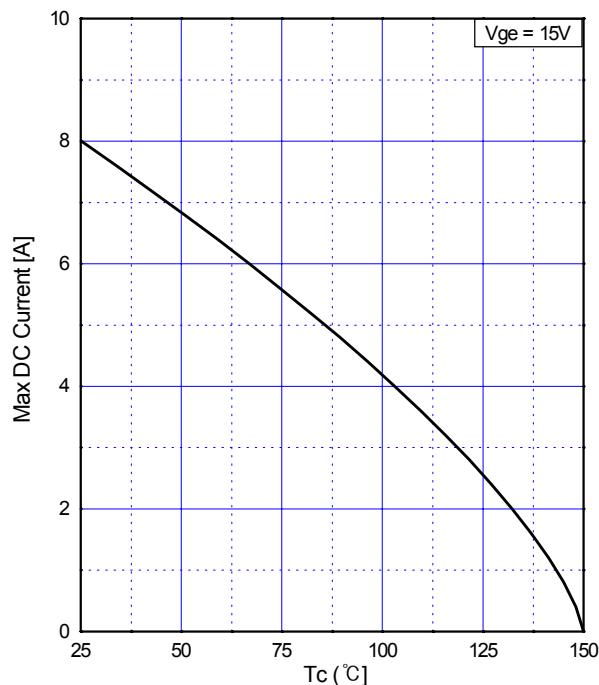


Fig.3 Maximum Collector Current vs. Case Temperature

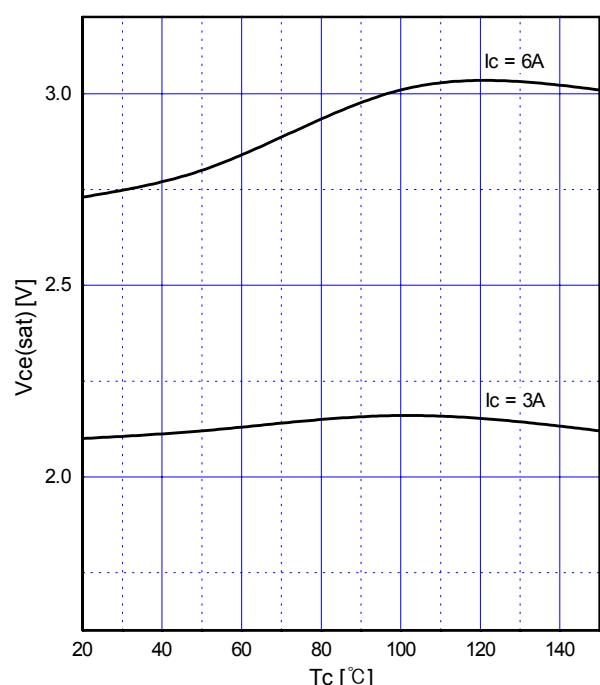


Fig.4 Collector to Emitter Voltage vs. Case Temperature

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## N-CHANNEL IGBT

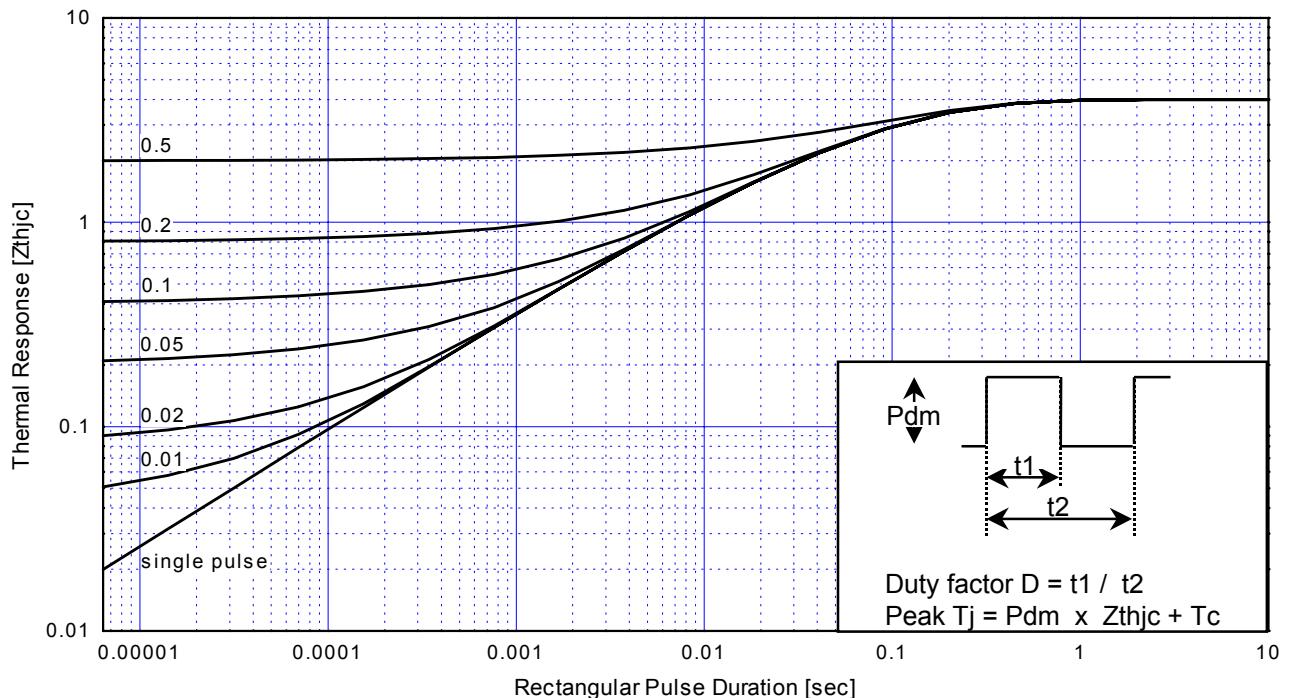


Fig.5 Maximum Effective Transient Thermal Impedance, Junction to Case

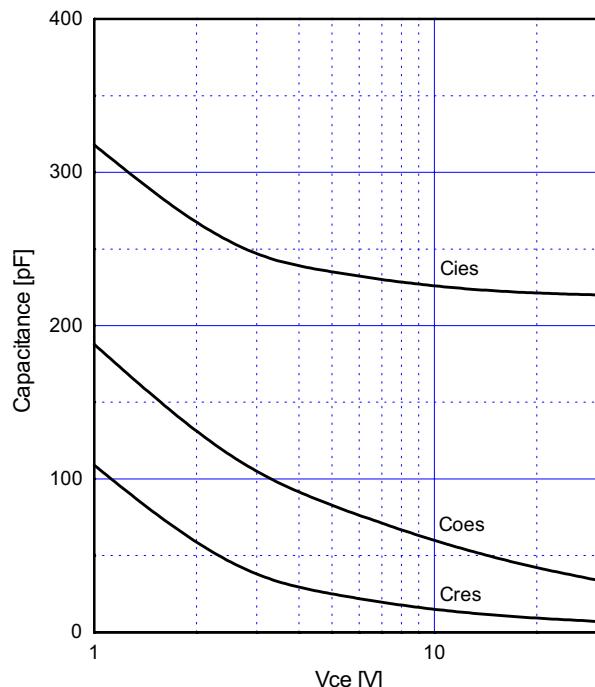


Fig.6 Typical Capacitance vs.  
Collector to Emitter Voltage

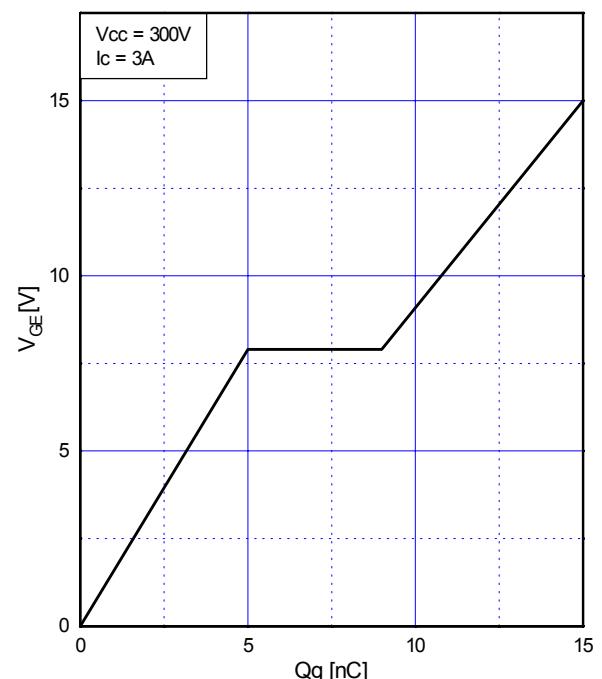


Fig.7 Typical Gate Charge vs.  
Gate to Emitter Voltage

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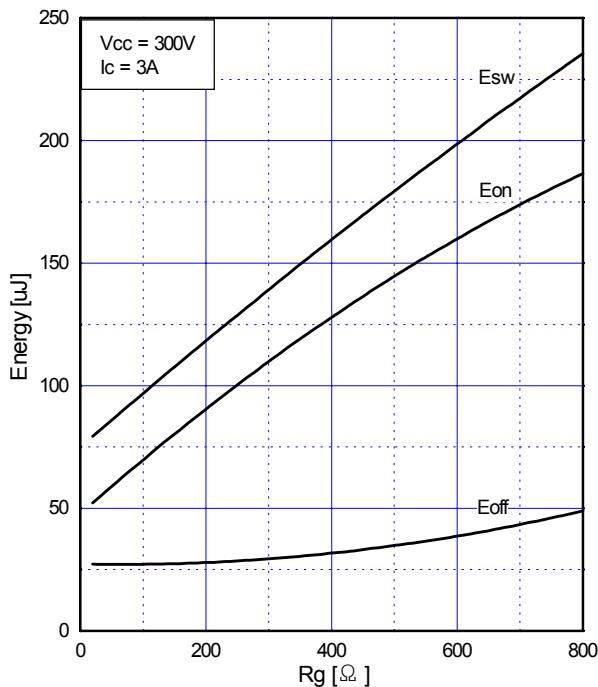


Fig.8 Typical Switching Loss vs.  
Gate Resistance

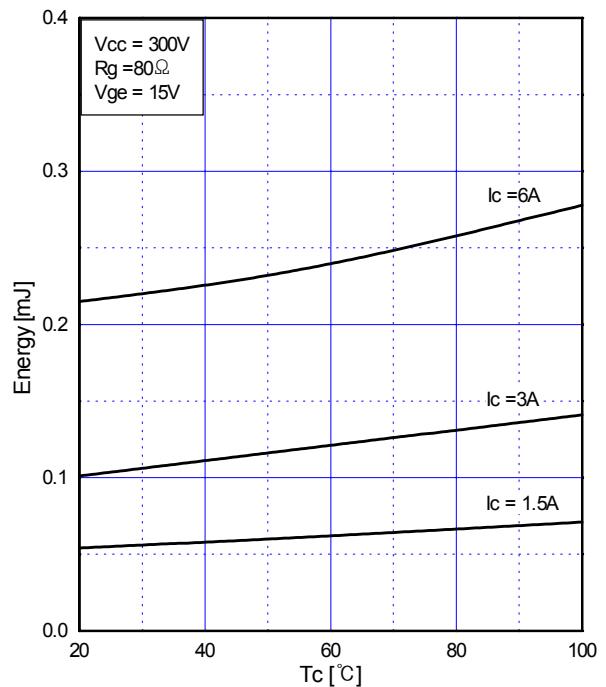


Fig.9 Typical Switching Loss vs.  
Case Temperature

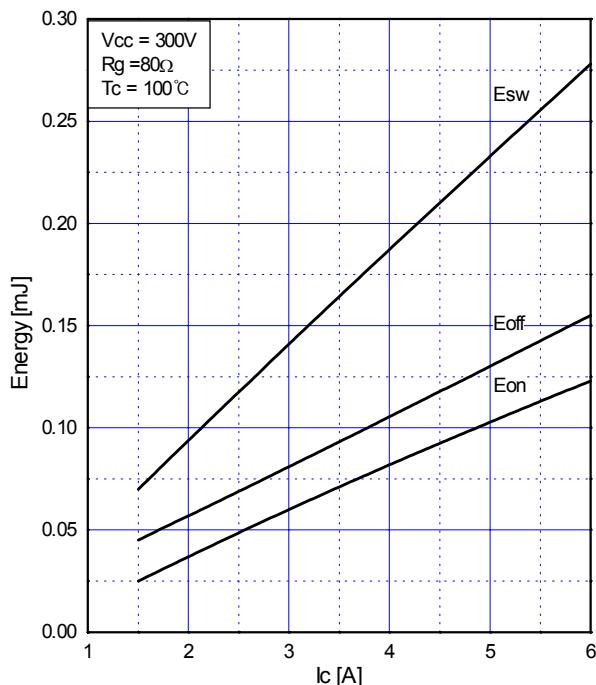


Fig.10 Typical Switching loss vs.  
Collector to Emitter Current

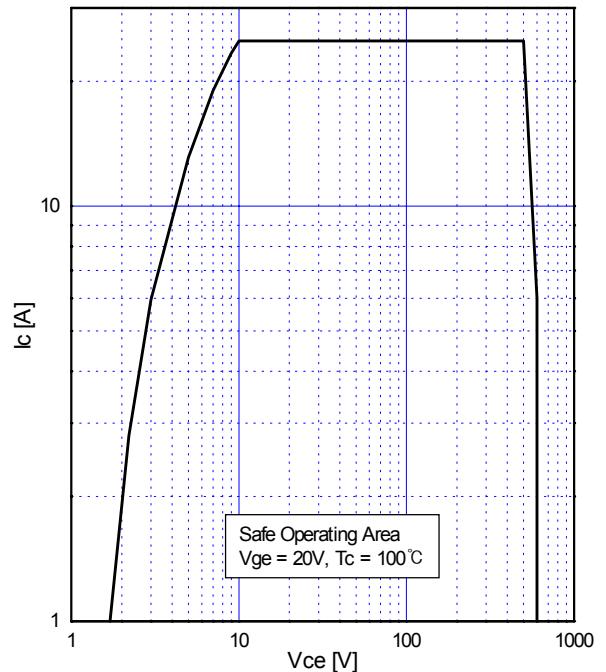


Fig.11 Turn-off SOA

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## N-CHANNEL IGBT

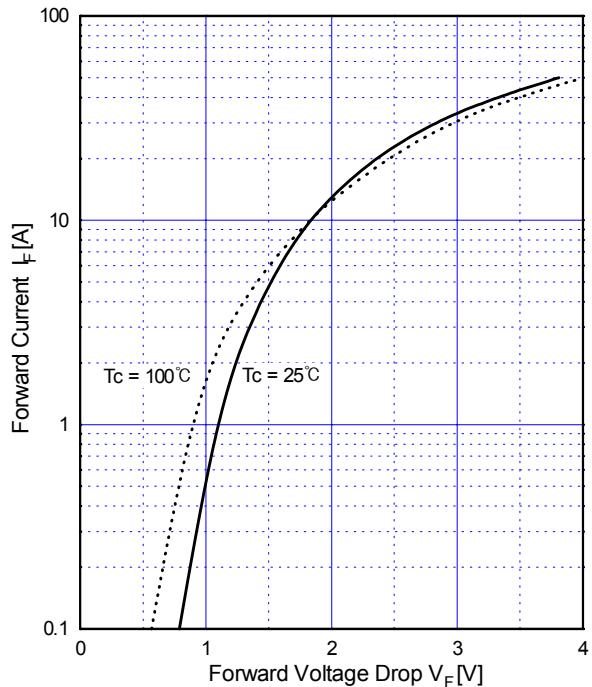


Fig.12 Typical Forward Voltage Drop  
vs. Forward Current

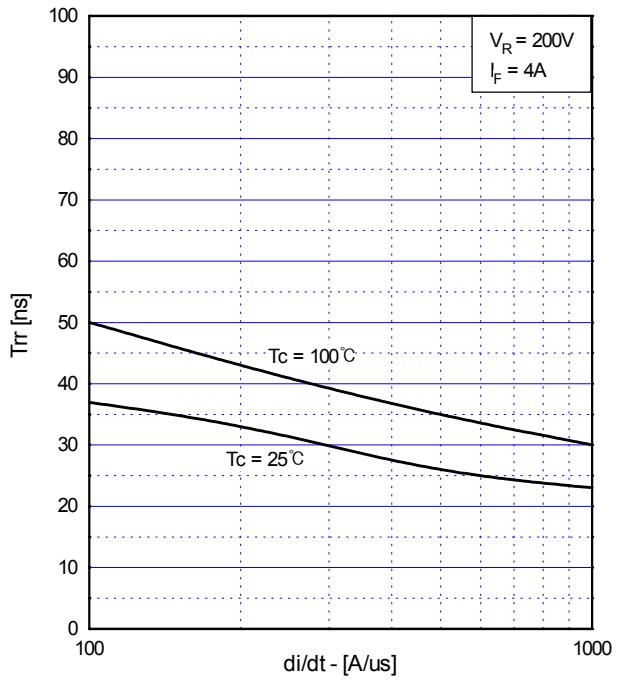


Fig.13 Typical Reverse Recovery Time  
vs.  $di/dt$

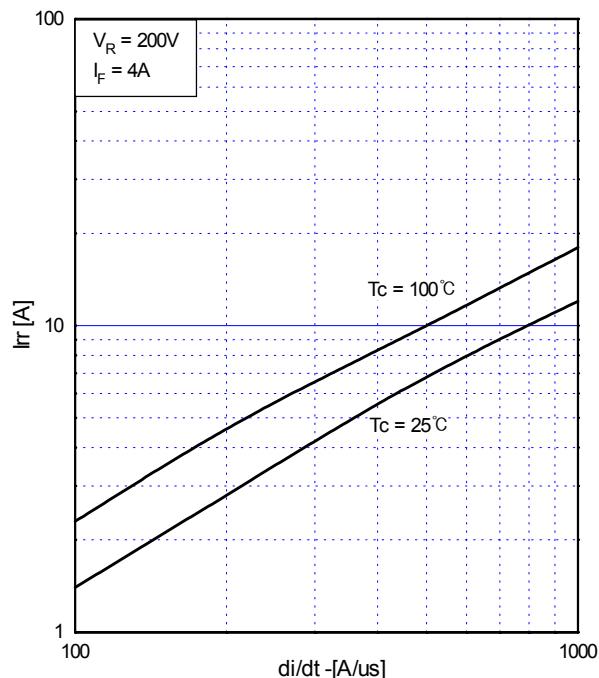


Fig.14 Typical Reverse Recovery Current  
vs.  $di/dt$

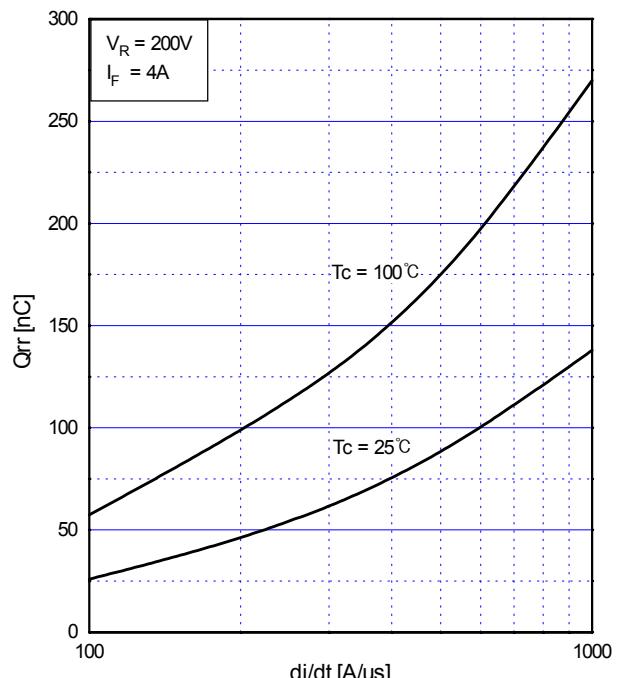


Fig.15 Typical Stored Charge vs.  $di/dt$